

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Micron Technology, Inc.	10/03/2008
RECEIVING PARTY DATA	
Name:	Aptina Imaging Corporation
Street Address:	c/o Citco Trustees (Cayman) Limited
Internal Address:	Regatta Office Park, West Bay Road
City:	Grand Cayman
State/Country:	CAYMAN ISLANDS
Postal Code:	Y1-1205
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	11209774
CORRESPONDENCE DATA	
Fax Number:	(202)420-2201
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	202-420-2200
Email:	bakerm@dsmo.com
Correspondent Name:	Dickstein Shapiro LLP
Address Line 1:	1825 Eye Street, NW
Address Line 4:	Washington, DISTRICT OF COLUMBIA 20006
ATTORNEY DOCKET NUMBER:	M4065.1177/P1177
NAME OF SUBMITTER:	Madeline E. Baker
<p>Total Attachments: 7</p> <p>source=Document#page1.tif</p> <p>source=Document#page2.tif</p> <p>source=Document#page3.tif</p>	

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PATENT ASSIGNMENT AGREEMENT

1. Definitions

(a) "Agreement" shall mean this Patent Assignment Agreement.

(b) "Assignee" shall mean **Aptina Imaging Corporation**, a Cayman Islands corporation with offices at c/o Citco Trustees (Cayman) Limited, Regatta Office Park, West Bay Road, Grand Cayman, Y1-1205, Cayman Islands.

(c) "Assignor" shall mean **Micron Technology, Inc.**, a Delaware corporation with offices at 8000 South Federal Way, Boise, ID 83707.

(d) "Effective Date" shall mean October 3, 2008.

(e)



(f)



(g) "Imaging Patents" shall mean those patents identified in ATTACHMENT "A" hereto, including, without limitation, all divisions, continuations, continuations-in-part, reissues, reexaminations, and all foreign counterparts thereof, and which may issue thereon or in connection therewith after the Effective Date of this Agreement.

(h) "Imaging Patent Applications" shall mean those filed patent applications identified in ATTACHMENT "B" hereto, including, without limitation, all patents, divisions, continuations, continuations-in-part, reissues, reexaminations, and all foreign counterparts which may issue thereon or in connection therewith after the Effective Date of this Agreement.

(i) "Semiconductor Patents" shall mean those patents identified in ATTACHMENT "D" hereto, including, without limitation, all divisions, continuations, continuations-in-part, reissues, reexaminations, and all foreign counterparts thereof, and which may issue thereon or in connection therewith after the Effective Date of this Agreement.

(j) "Semiconductor Patent Applications" shall mean those filed patent applications identified in ATTACHMENT "E" hereto, including, without limitation, all patents, divisions, continuations, continuations-in-part, reissues, reexaminations, and all foreign counterparts which may issue thereon or in connection therewith after the Effective Date of this Agreement.

(k)

2.

(a) Subject to the terms and conditions of this Agreement, and subject to the rights of others existing as of the Effective Date of this Agreement if any, Assignor, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, hereby sells, assigns, and transfers to Assignee its entire right, title and interest in and to the Imaging Patents, including all rights to causes of action and remedies related thereto (including the right to sue for past, present or future infringement of rights related to the foregoing and the right to collect damages therefor). Assignor hereby authorizes and requests the Commissioner of Patents of the United States, and any other official of the United States and any country foreign to the United States whose duty it is to issue or record patents, to issue the Imaging Patents to Assignee and to record assignment of the Imaging Patents to Assignee.

(b) Subject to the terms and conditions of this Agreement, and subject to the rights of others existing as of the Effective Date of this Agreement if any, Assignor, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, hereby sells, assigns, and transfers to Assignee its entire right, title and interest in and to the Intellectual Property rights in the Imaging Patent Applications. Assignor hereby authorizes and requests the Commissioner of Patents of the United States, and any other official of the United States and any country foreign to the United States whose duty it is to issue or record patents, to record assignment of the Imaging Patent Applications to Assignee.

(c)

(d) Subject to the terms and conditions of this Agreement, and subject to the rights of others existing as of the Effective Date of this Agreement if any, and subject further to the restrictions on the Semiconductor Patents set out below, Assignor, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, hereby sells, assigns, and transfers to Assignee its entire right, title and interest in and to the Semiconductor Patents, including all rights to causes of action and remedies related thereto (including the right to sue for past, present or future infringement of rights related to the foregoing and the right to collect damages therefor). Assignor hereby authorizes and requests the Commissioner of Patents of the United States, and any other official of the United States and any country foreign to the United States whose duty it is to issue or record patents, to issue the Semiconductor Patents to Assignee and to record assignment of the Semiconductor Patents to Assignee.

(e) Subject to the terms and conditions of this Agreement, and subject to the rights of others existing as of the Effective Date of this Agreement if any, Assignor, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, hereby sells, assigns, and transfers to Assignee its entire right, title and interest in and to the Intellectual Property rights in the Semiconductor Patent Applications. Assignor hereby authorizes and requests the Commissioner of Patents of the United States, and any other official of the United States and any country foreign to the United States whose duty it is to issue or record patents, to record assignment of the Semiconductor Patent Applications to Assignee.

(f)

[REDACTED]

[REDACTED]

[REDACTED]

[REDACTED]

3

[REDACTED]

[REDACTED]

4.

[REDACTED]

[REDACTED]

5.

[REDACTED]

[REDACTED]

[REDACTED]

6. [REDACTED]

[REDACTED]

7. **General**

This Agreement shall be effective as of the Effective Date hereof and shall be binding on the respective heirs, assigns, representatives, and successors of Assignor and of Assignee.

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Agreed to by:

Micron Technology, Inc.

Signed: _____

Date: _____

9/26/08

, 2008

Notarization

State of Idaho

County of Ada

On 9/26/08, before me, _____

(date)

Paula R. Spang
(notary name)

, personally appeared the above-named _____

Stan R. Appleton

who executed this Assignment in my presence and acknowledged to me that he did so of his own free will and in his authorized capacity for the purposes set forth herein.

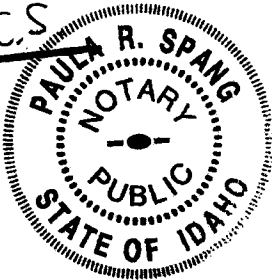
Signed: _____

My commission expires: _____

8/12/11

REVIEWED
MTI LEGAL

C.S.



Agreed to by:

Aptina Imaging Corporation

Signed: _____

Date: _____

9/26/08

, 2008

Notarization

State of Idaho

County of Ada

On 9/26/08, before me, _____

(date)

Paula R. Spang
(notary name)

, personally appeared the above-named _____

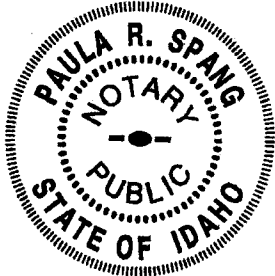
Thomas L. Lane, Jr.

who executed this Assignment in my presence and acknowledged to me that he did so of his own free will and in his authorized capacity for the purposes set forth herein.

Signed: _____

My commission expires: _____

8/12/11



[Signature page to the Patent Assignment Agreement]

ATTACHMENT "B"



Aptina Applications

FILE NUMBER	TITLE	STATUS	COUNTRY NAME	APPLICATION NUMBER	DATE FILED
	GATES				
2004-1197.00/KR	METHOD AND APPARATUS FOR PROVIDING AN INTEGRATED CIRCUIT HAVING P AND N DOPED GATES	Pending	Republic of Korea		Jan 5, 2007
2004-1197.00/PC	METHOD AND APPARATUS FOR PROVIDING AN INTEGRATED CIRCUIT HAVING P AND N DOPED GATES	Completed	PCT	PCTUS2007000407	Jan 5, 2007
2004-1197.00/SG	METHOD AND APPARATUS FOR PROVIDING AN INTEGRATED CIRCUIT HAVING P AND N DOPED GATES	Pending	Singapore		Jan 5, 2007
2004-1197.00/TW	METHOD AND APPARATUS FOR PROVIDING AN INTEGRATED CIRCUIT HAVING P AND N DOPED GATES	Pending	Taiwan R.O.C.	096100819	Jan 9, 2007
2004-1197.00/US	METHOD AND APPARATUS FOR PROVIDING AN INTEGRATED CIRCUIT HAVING P AND N DOPED GATES	Pending	United States of America	11327377	Jan 9, 2006
2004-1228.01/US	METHOD AND APPARATUS PROVIDING GRADED-INDEX MICRO LENSES	Pending	United States of America	11501055	Aug 9, 2006
2004-1228.02/US	METHOD AND APPARATUS PROVIDING GRADED-INDEX MICRO LENSES	Pending	United States of America	11797317	May 2, 2007
2004-1250.00/US	METHOD AND APPARATUS PROVIDING INTEGRATED COLOR PIXEL WITH BURIED SUB-WAVELENGTH GRATINGS IN SOLID STATE IMAGERS	Pending	United States of America	11209774	Aug 24, 2005
2004-1299.00/US	STRUCTURE AND METHOD FOR BUILDING A PIXEL WAVEGUIDE ON IMAGING DEVICES	Pending	United States of America	11183450	Aug 1, 2005
2004-1355.00/CN	COLOR PIXELS WITH ANTI-BLOOMING ISOLATION	Pending	China	2006800158256	May 12, 2006